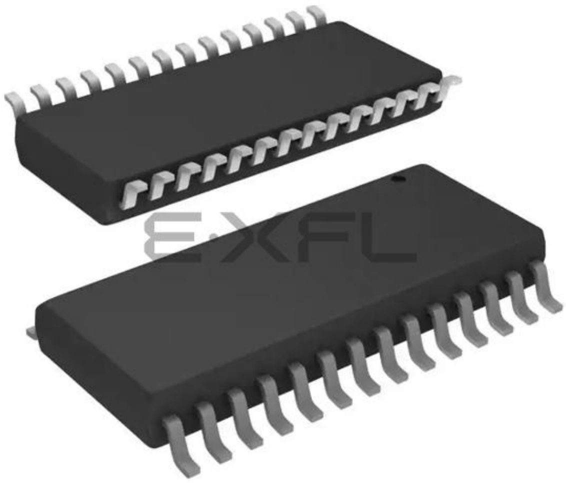

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Peripherals	Brown-out Detect/Reset, Motor Control PWM, QEI, POR, PWM, WDT
Number of I/O	20
Program Memory Size	24KB (8K x 24)
Program Memory Type	FLASH
EEPROM Size	1K x 8
RAM Size	1K x 8
Voltage - Supply (Vcc/Vdd)	2.5V ~ 5.5V
Data Converters	A/D 6x10b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
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dsPIC30F Motor Control and Power Conversion Family

Device	Pins	Program Mem. Bytes/ Instructions	SRAM Bytes	EEPROM Bytes	Timer 16-Bit	Input Cap	Output Comp/Std PWM	Motor Control PWM	A/D 10-Bit 1 Msps	Quad Enc	UART	SPI	I^2C^{TM}
dsPIC30F3010	28	24K/8K	1024	1024	5	4	2	6 ch	6 ch	Yes	1	1	1
dsPIC30F3011	40/44	24K/8K	1024	1024	5	4	4	6 ch	9 ch	Yes	2	1	1

TABLE 1-2: dsPIC30F3010 I/O PIN DESCRIPTIONS (CONTINUED)

Pin Name	Pin Type	Buffer Type	Description
OSC1 OSC2	I I/O	ST/CMOS —	Oscillator crystal input. ST buffer when configured in RC mode; CMOS otherwise. Oscillator crystal output. Connects to crystal or resonator in Crystal Oscillator mode. Optionally functions as CLKO in RC and EC modes.
PGD PGC	I/O I	ST ST	In-Circuit Serial Programming data input/output pin. In-Circuit Serial Programming clock input pin.
RB0-RB5	I/O	ST	PORTB is a bidirectional I/O port.
RC13-RC15	I/O	ST	PORTC is a bidirectional I/O port.
RD0-RD1	I/O	ST	PORTD is a bidirectional I/O port.
RE0-RE5, RE8	I/O	ST	PORTE is a bidirectional I/O port.
RF2-RF3	I/O	ST	PORTF is a bidirectional I/O port.
SCK1 SDI1 SDO1	I/O I O	ST ST —	Synchronous serial clock input/output for SPI1. SPI1 Data In. SPI1 Data Out.
SCL SDA	I/O I/O	ST ST	Synchronous serial clock input/output for I^2C. Synchronous serial data input/output for I^2C.
SOSCO SOSCI	O I	— ST/CMOS	32 kHz low-power oscillator crystal output. 32 kHz low-power oscillator crystal input. ST buffer when configured in RC mode; CMOS otherwise.
T1CK T2CK	I I	ST ST	Timer1 external clock input. Timer2 external clock input.
U1RX U1TX U1ARX U1ATX	I O I O	ST — ST —	UART1 Receive. UART1 Transmit. UART1 Alternate Receive. UART1 Alternate Transmit.
V_{DD}	P	—	Positive supply for logic and I/O pins.
V_{SS}	P	—	Ground reference for logic and I/O pins.
V_{REF+}	I	Analog	Analog Voltage Reference (High) input.
V_{REF-}	I	Analog	Analog Voltage Reference (Low) input.

Legend: CMOS = CMOS compatible input or output; Analog = Analog input
ST = Schmitt Trigger input with CMOS levels; O = Output
I = Input; P = Power

3.0 MEMORY ORGANIZATION

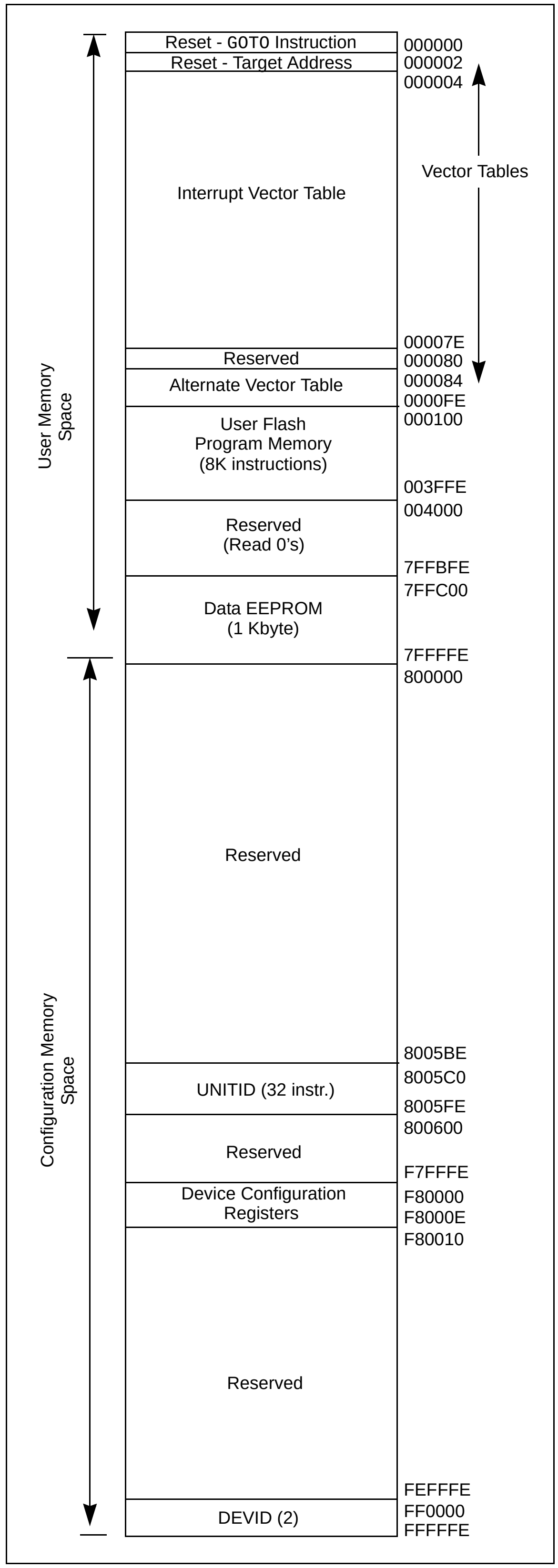
Note:	This data sheet summarizes features of this group of dsPIC30F devices and is not intended to be a complete reference source. For more information on the CPU, peripherals, register descriptions and general device functionality, refer to the "*dsPIC30F Family Reference Manual*" (DS70046). For more information on the device instruction set and programming, refer to the "*16-bit MCU and DSC Programmer's Reference Manual*" (DS70157).

3.1 Program Address Space

The program address space is 4M instruction words. It is addressable by the 23-bit PC, table instruction Effective Address (EA) or data space EA, when program space is mapped into data space, as defined by Table 3-1. Note that the program space address is incremented by two between successive program words in order to provide compatibility with data space addressing.

User program space access is restricted to the lower 4M instruction word address range (0x000000 to 0x7FFFFE) for all accesses other than TBLRD/TBLWT, which use TBLPAG<7> to determine user or configuration space access. In Table 3-1, read/write instructions, bit 23 allows access to the Device ID, the User ID and the Configuration bits; otherwise, bit 23 is always clear.

FIGURE 3-1: PROGRAM SPACE MEMORY MAP FOR dsPIC30F3010/3011



3.1.1 DATA ACCESS FROM PROGRAM MEMORY USING TABLE INSTRUCTIONS

This architecture fetches 24-bit wide program memory. Consequently, instructions are always aligned. However, as the architecture is modified Harvard, data can also be present in program space.

There are two methods by which program space can be accessed: via special table instructions, or through the remapping of a 16K word program space page into the upper half of data space (see **Section 3.1.2 "Data Access From Program Memory Using Program Space Visibility"**). The `TBLRDL` and `TBLWTL` instructions offer a direct method of reading or writing the lsw of any address within program space, without going through data space. The `TBLRDH` and `TBLWTH` instructions are the only method whereby the upper 8 bits of a program space word can be accessed as data.

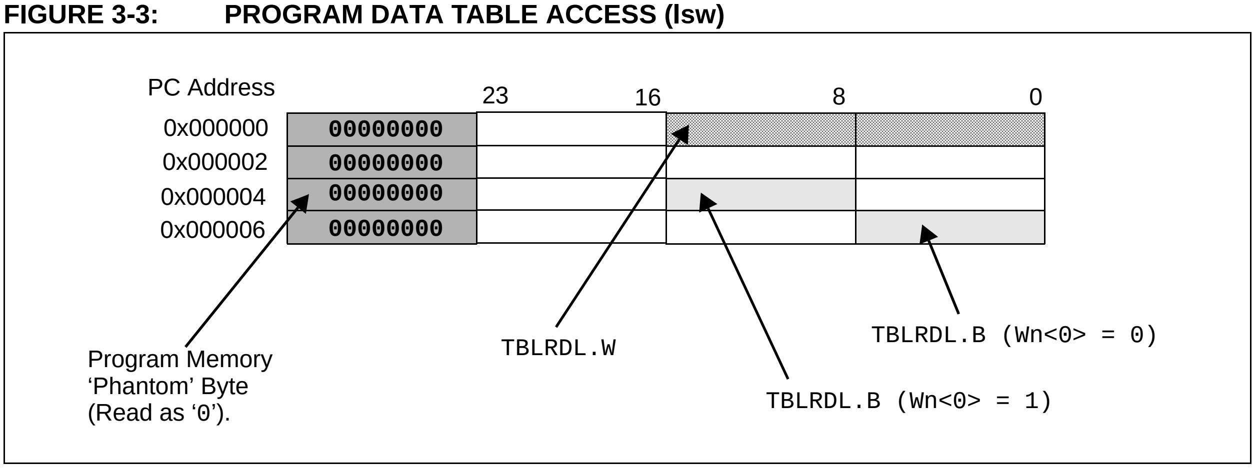
The PC is incremented by two for each successive 24-bit program word. This allows program memory addresses to directly map to data space addresses. Program memory can thus be regarded as two 16-bit word-wide address spaces, residing side by side, each with the same address range. `TBLRDL` and `TBLWTL` access the space which contains the lsw, and `TBLRDH` and `TBLWTH` access the space which contains the MSB.

Figure 3-2 illustrates how the EA is created for table operations and data space accesses (PSV = `1`). Here, P<23:0> refers to a program space word, whereas D<15:0> refers to a data space word.

A set of table instructions are provided to move byte or word-sized data to and from program space.

1. **`TBLRDL:`** Table Read Low
   Word: Read the lsw of the program address;
   P<15:0> maps to D<15:0>.
   Byte: Read one of the LSBs of the program address;
   P<7:0> maps to the destination byte when byte select = `0`;
   P<15:8> maps to the destination byte when byte select = `1`.
2. **`TBLWTL:`** Table Write Low (refer to **Section 6.0 "Flash Program Memory"** for details on Flash programming).
3. **`TBLRDH:`** Table Read High
   Word: Read the msw of the program address;
   P<23:16> maps to D<7:0>; D<15:8> will always be = `0`.
   Byte: Read one of the MSBs of the program address;
   P<23:16> maps to the destination byte when byte select = `0`;
   The destination byte will always be = `0` when byte select = `1`.
4. **`TBLWTH:`** Table Write High (refer to **Section 6.0 "Flash Program Memory"** for details on Flash programming).

FIGURE 3-3: PROGRAM DATA TABLE ACCESS (lsw)



NOTES:

4.0 ADDRESS GENERATOR UNITS

> **Note:** This data sheet summarizes features of this group of dsPIC30F devices and is not intended to be a complete reference source. For more information on the CPU, peripherals, register descriptions and general device functionality, refer to the "*dsPIC30F Family Reference Manual"* (DS70046). For more information on the device instruction set and programming, refer to the "*16-bit MCU and DSC Programmer's Reference Manual"* (DS70157).

The dsPIC DSC core contains two independent address generator units: the X AGU and Y AGU. The Y AGU supports word-sized data reads for the DSP `MAC` class of instructions only. The dsPIC DSC AGUs support three types of data addressing:

- Linear Addressing
- Modulo (Circular) Addressing
- Bit-Reversed Addressing

Linear and Modulo Data Addressing modes can be applied to data space or program space. Bit-Reversed Addressing is only applicable to data space addresses.

4.1 Instruction Addressing Modes

The addressing modes in Table 4-1 form the basis of the addressing modes optimized to support the specific features of individual instructions. The addressing modes provided in the `MAC` class of instructions are somewhat different from those in the other instruction types.

4.1.1 FILE REGISTER INSTRUCTIONS

Most file register instructions use a 13-bit address field (f) to directly address data present in the first 8192 bytes of data memory (near data space). Most file register instructions employ a working register, W0, which is denoted as WREG in these instructions. The destination is typically either the same file register, or WREG (with the exception of the `MUL` instruction), which writes the result to a register or register pair. The `MOV` instruction allows additional flexibility and can access the entire data space during file register operation.

4.1.2 MCU INSTRUCTIONS

The three-operand MCU instructions are of the form:

```
Operand 3 = Operand 1 <function> Operand 2
```

where Operand 1 is always a working register (i.e., the addressing mode can only be Register Direct), which is referred to as Wb. Operand 2 can be a W register, fetched from data memory, or a 5-bit literal. The result location can be either a W register or an address location. The following addressing modes are supported by MCU instructions:

- Register Direct
- Register Indirect
- Register Indirect Post-Modified
- Register Indirect Pre-Modified
- 5-bit or 10-bit Literal

> **Note:** Not all instructions support all the addressing modes given above. Individual instructions may support different subsets of these addressing modes.

TABLE 4-1: FUNDAMENTAL ADDRESSING MODES SUPPORTED

Addressing Mode	Description
File Register Direct	The address of the file register is specified explicitly.
Register Direct	The contents of a register are accessed directly.
Register Indirect	The contents of Wn forms the EA.
Register Indirect Post-Modified	The contents of Wn forms the EA. Wn is post-modified (incremented or decremented) by a constant value.
Register Indirect Pre-Modified	Wn is pre-modified (incremented or decremented) by a signed constant value to form the EA.
Register Indirect with Register Offset	The sum of Wn and Wb forms the EA.
Register Indirect with Literal Offset	The sum of Wn and a literal forms the EA.

10.1 Timer Gate Operation

The 32-bit timer can be placed in the Gated Time Accumulation mode. This mode allows the internal TCY to increment the respective timer when the gate input signal (T2CK pin) is asserted high. Control bit, TGATE (T2CON<6>), must be set to enable this mode. When in this mode, Timer2 is the originating clock source. The TGATE setting is ignored for Timer3. The timer must be enabled (TON = 1) and the timer clock source set to internal (TCS = 0).

The falling edge of the external signal terminates the count operation, but does not reset the timer. The user must reset the timer in order to start counting from zero.

10.2 ADC Event Trigger

When a match occurs between the 32-bit timer (TMR3/TMR2) and the 32-bit combined Period register (PR3/PR2), a special ADC trigger event signal is generated by Timer3.

10.3 Timer Prescaler

The input clock (FOSC/4 or external clock) to the timer has a prescale option of 1:1, 1:8, 1:64 and 1:256, selected by control bits, TCKPS<1:0> (T2CON<5:4> and T3CON<5:4>). For the 32-bit timer operation, the originating clock source is Timer2. The prescaler operation for Timer3 is not applicable in this mode. The prescaler counter is cleared when any of the following occurs:

- A write to the TMR2/TMR3 register
- Clearing either of the TON (T2CON<15> or T3CON<15>) bits to ‘0’
- A device Reset such as a POR and BOR

However, if the timer is disabled (TON = 0), the Timer2 prescaler cannot be reset, since the prescaler clock is halted.

TMR2/TMR3 is not cleared when T2CON/T3CON is written.

10.4 Timer Operation During Sleep Mode

During CPU Sleep mode, the timer will not operate, because the internal clocks are disabled.

10.5 Timer Interrupt

The 32-bit timer module can generate an interrupt-on-period match, or on the falling edge of the external gate signal. When the 32-bit timer count matches the respective 32-bit Period register, or the falling edge of the external “gate” signal is detected, the T3IF bit (IFS0<7>) is asserted and an interrupt will be generated if enabled. In this mode, the T3IF interrupt flag is used as the source of the interrupt. The T3IF bit must be cleared in software.

Enabling an interrupt is accomplished via the respective Timer Interrupt Enable bit, T3IE (IEC0<7>).

TABLE 11-1: TIMER4/5 REGISTER MAP(1)

SFR Name	Addr.	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset State
TMR4	0114	Timer4 Register																uuuu uuuu uuuu uuuu
TMR5HLD	0116	Timer5 Holding Register (For 32-bit operations only)																uuuu uuuu uuuu uuuu
TMR5	0118	Timer5 Register																uuuu uuuu uuuu uuuu
PR4	011A	Period Register 4																1111 1111 1111 1111
PR5	011C	Period Register 5																1111 1111 1111 1111
T4CON	011E	TON	—	TSIDL	—	—	—	—	—	—	TGATE	TCKPS1	TCKPS0	T45	—	TCS	—	0000 0000 0000 0000
T5CON	0120	TON	—	TSIDL	—	—	—	—	—	—	TGATE	TCKPS1	TCKPS0	—	—	TCS	—	0000 0000 0000 0000

Legend: u = uninitialized bit; — = unimplemented bit, read as ‘0’

Note 1: Refer to *“dsPIC30F Family Reference Manual”* (DS70046) for descriptions of register bit fields.

When the PWM time base is in the Continuous Up/ Down Count mode with double updates, new duty cycle values are updated when the value of the PTMR register is zero, and when the value of the PTMR register matches the value in the PTPER register. The contents of the duty cycle buffers are automatically loaded into the Duty Cycle registers when the PWM time base is disabled (PTEN = 0).

15.6 Complementary PWM Operation

In the Complementary mode of operation, each pair of PWM outputs is obtained by a complementary PWM signal. A dead time may be optionally inserted during device switching, when both outputs are inactive for a short period (Refer to **Section 15.7 "Dead-Time Generators"**).

In Complementary mode, the duty cycle comparison units are assigned to the PWM outputs as follows:

- PDC1 register controls PWM1H/PWM1L outputs
- PDC2 register controls PWM2H/PWM2L outputs
- PDC3 register controls PWM3H/PWM3L outputs

The Complementary mode is selected for each PWM I/O pin pair by clearing the appropriate PMODx bit in the PWMCON1 SFR. The PWM I/O pins are set to Complementary mode by default upon a device Reset.

15.7 Dead-Time Generators

Dead-time generation may be provided when any of the PWM I/O pin pairs are operating in the Complementary Output mode. The PWM outputs use push-pull drive circuits. Due to the inability of the power output devices to switch instantaneously, some amount of time must be provided between the turn-off event of one PWM output in a complementary pair and the turn-on event of the other transistor.

The PWM module allows two different dead times to be programmed. These two dead times may be used in one of two methods described below to increase user flexibility:

- The PWM output signals can be optimized for different turn-off times in the high side and low side transistors in a complementary pair of transistors. The first dead time is inserted between the turn-off event of the lower transistor of the complementary pair and the turn-on event of the upper transistor. The second dead time is inserted between the turn-off event of the upper transistor and the turn-on event of the lower transistor.
- The two dead times can be assigned to individual PWM I/O pin pairs. This operating mode allows the PWM module to drive different transistor/load combinations with each complementary PWM I/O pin pair.

15.7.1 DEAD-TIME GENERATORS

Each complementary output pair for the PWM module has a 6-bit down counter that is used to produce the dead-time insertion. As shown in Figure 15-4, each dead-time unit has a rising and falling edge detector connected to the duty cycle comparison output.

15.7.2 DEAD-TIME RANGES

The amount of dead time provided by the dead-time unit is selected by specifying the input clock prescaler value and a 6-bit unsigned value.

Four input clock prescaler selections have been provided to allow a suitable range of dead time, based on the device operating frequency. The dead-time clock prescaler values are selected using the DTAPS<1:0> control bits in the DTCON1 SFR. One of four clock prescaler options (TCY, 2 TCY, 4 TCY or 8 TCY) may be selected.

After the prescaler value is selected, the dead time is adjusted by loading 6-bit unsigned values into the DTCON1 SFR.

The dead-time unit prescaler is cleared on the following events:

- On a load of the down timer due to a duty cycle comparison edge event.
- On a write to the DTCON1 register.
- On any device Reset.

Note:	The user should not modify the DTCON1 value while the PWM module is operating (PTEN = 1). Unexpected results may occur.

17.2 I^{2}C Module Addresses

The I2CADD register contains the Slave mode addresses. The register is a 10-bit register.

If the A10M bit (I2CCON<10>) is '0', the address is interpreted by the module as a 7-bit address. When an address is received, it is compared to the 7 LSbs of the I2CADD register.

If the A10M bit is '1', the address is assumed to be a 10-bit address. When an address is received, it will be compared with the binary value, '11110 A9 A8' (where A9 and A8 are two Most Significant bits of I2CADD). If that value matches, the next address will be compared with the Least Significant 8 bits of I2CADD, as specified in the 10-bit addressing protocol.

The 7-bit I^{2}C slave addresses supported by the dsPIC30F are shown in Table 17-1.

TABLE 17-1: 7-BIT I^{2}C™ SLAVE ADDRESSES

Address	Description
0x00	General Call Address or Start Byte
0x01-0x03	Reserved
0x04-0x07	HS mode Master Codes
0x08-0x77	Valid 7-Bit Addresses
0x78-0x7B	Valid 10-Bit Addresses (lower 7 bits)
0x7C-0x7F	Reserved

17.3 I^{2}C 7-Bit Slave Mode Operation

Once enabled (I2CEN = 1), the slave module will wait for a Start bit to occur (i.e., the I^{2}C module is 'Idle'). Following the detection of a Start bit, 8 bits are shifted into I2CRSR and the address is compared against I2CADD. In 7-bit mode (A10M = 0), bits I2CADD<6:0> are compared against I2CRSR<7:1> and I2CRSR<0> is the R_W bit. All incoming bits are sampled on the rising edge of SCL.

If an address match occurs, an Acknowledgement will be sent, and the Slave Event Interrupt Flag (SI2CIF) is set on the falling edge of the ninth ($\overline{\text{ACK}}$) bit. The address match does not affect the contents of the I2CRCV buffer or the RBF bit.

17.3.1 SLAVE TRANSMISSION

If the R_W bit received is a '1', then the serial port will go into Transmit mode. It will send an $\overline{\text{ACK}}$ on the ninth bit and then hold SCL to '0' until the CPU responds by writing to I2CTRN. SCL is released by setting the SCLREL bit, and 8 bits of data are shifted out. Data bits are shifted out on the falling edge of SCL, such that SDA is valid during SCL high. The interrupt pulse is sent on the falling edge of the ninth clock pulse, regardless of the status of the $\overline{\text{ACK}}$ received from the master.

17.3.2 SLAVE RECEPTION

If the R_W bit received is a '0' during an address match, then Receive mode is initiated. Incoming bits are sampled on the rising edge of SCL. After 8 bits are received, if I2CRCV is not full or I2COV is not set, I2CRSR is transferred to I2CRCV. $\overline{\text{ACK}}$ is sent on the ninth clock.

If the RBF flag is set, indicating that I2CRCV is still holding data from a previous operation (RBF = 1), then $\overline{\text{ACK}}$ is not sent; however, the interrupt pulse is generated. In the case of an overflow, the contents of the I2CRSR are not loaded into the I2CRCV.

> **Note:** The I2CRCV will be loaded if the I2COV bit = 1 and the RBF flag = 0. In this case, a read of the I2CRCV was performed, but the user did not clear the state of the I2COV bit before the next receive occurred. The Acknowledgement is not sent ($\overline{\text{ACK}}$ = 1) and the I2CRCV is updated.

17.4 I^{2}C 10-Bit Slave Mode Operation

In 10-bit mode, the basic receive and transmit operations are the same as in the 7-bit mode. However, the criteria for address match is more complex.

The I^{2}C specification dictates that a slave must be addressed for a write operation, with two address bytes following a Start bit.

The A10M bit is a control bit that signifies that the address in I2CADD is a 10-bit address rather than a 7-bit address. The address detection protocol for the first byte of a message address is identical for 7-bit and 10-bit messages, but the bits being compared are different.

I2CADD holds the entire 10-bit address. Upon receiving an address following a Start bit, I2CRSR<7:3> is compared against a literal '11110' (the default 10-bit address) and I2CRSR<2:1> are compared against I2CADD<9:8>. If a match occurs and if R_W = 0, the interrupt pulse is sent. The ADD10 bit will be cleared to indicate a partial address match. If a match fails or R_W = 1, the ADD10 bit is cleared and the module returns to the Idle state.

The low byte of the address is then received and compared with I2CADD<7:0>. If an address match occurs, the interrupt pulse is generated and the ADD10 bit is set, indicating a complete 10-bit address match. If an address match did not occur, the ADD10 bit is cleared and the module returns to the Idle state.

17.7 Interrupts

The I²C module generates two interrupt flags, MI2CIF (I²C Master Interrupt Flag) and SI2CIF (I²C Slave Interrupt Flag). The MI2CIF interrupt flag is activated on completion of a master message event. The SI2CIF interrupt flag is activated on detection of a message directed to the slave.

17.8 Slope Control

The I²C standard requires slope control on the SDA and SCL signals for Fast mode (400 kHz). The control bit, DISSLW, enables the user to disable slew rate control, if desired. It is necessary to disable the slew rate control for 1 MHz mode.

17.9 IPMI Support

The control bit, IPMIEN, enables the module to support Intelligent Peripheral Management Interface (IPMI). When this bit is set, the module accepts and acts upon all addresses.

17.10 General Call Address Support

The general call address can address all devices. When this address is used, all devices should, in theory, respond with an Acknowledgement.

The general call address is one of eight addresses reserved for specific purposes by the I²C protocol. It consists of all '0's with R_W = 0.

The general call address is recognized when the General Call Enable (GCEN) bit is set (I2CCON<7> = 1). Following a Start bit detection, 8 bits are shifted into I2CRSR and the address is compared with I2CADD, and is also compared with the general call address which is fixed in hardware.

If a general call address match occurs, the I2CRSR is transferred to the I2CRCV after the eighth clock, the RBF flag is set, and on the falling edge of the ninth bit ($\overline{\text{ACK}}$ bit), the Master Event Interrupt Flag (MI2CIF) is set.

When the interrupt is serviced, the source for the interrupt can be checked by reading the contents of the I2CRCV to determine if the address was device-specific, or a general call address.

17.11 I²C Master Support

As a master device, six operations are supported:

- Assert a Start condition on SDA and SCL
- Assert a Restart condition on SDA and SCL
- Write to the I2CTRN register initiating transmission of data/address
- Generate a Stop condition on SDA and SCL
- Configure the I²C port to receive data
- Generate an $\overline{\text{ACK}}$ condition at the end of a received byte of data

17.12 I²C Master Operation

The master device generates all of the serial clock pulses and the Start and Stop conditions. A transfer is ended with a Stop condition or with a Repeated Start condition. Since the Repeated Start condition is also the beginning of the next serial transfer, the I²C bus will not be released.

In Master Transmitter mode, serial data is output through SDA, while SCL outputs the serial clock. The first byte transmitted contains the slave address of the receiving device (7 bits) and the data direction bit. In this case, the data direction bit (R_W) is logic '0'. Serial data is transmitted 8 bits at a time. After each byte is transmitted, an $\overline{\text{ACK}}$ bit is received. Start and Stop conditions are output to indicate the beginning and the end of a serial transfer.

In Master Receive mode, the first byte transmitted contains the slave address of the transmitting device (7 bits) and the data direction bit. In this case, the data direction bit (R_W) is logic '1'. Thus, the first byte transmitted is a 7-bit slave address, followed by a '1' to indicate the receive bit. Serial data is received via SDA, while SCL outputs the serial clock. Serial data is received 8 bits at a time. After each byte is received, an $\overline{\text{ACK}}$ bit is transmitted. Start and Stop conditions indicate the beginning and end of transmission.

17.12.1 I²C MASTER TRANSMISSION

Transmission of a data byte, a 7-bit address or the second half of a 10-bit address is accomplished by simply writing a value to I2CTRN register. The user should only write to I2CTRN when the module is in a Wait state. This action will set the Buffer Full Flag (TBF) and allow the Baud Rate Generator to begin counting and start the next transmission. Each bit of address/data will be shifted out onto the SDA pin after the falling edge of SCL is asserted. The Transmit Status Flag, TRSTAT (I2CSTAT<14>), indicates that a master transmit is in progress.

18.5.2 FRAMING ERROR (FERR)

The FERR bit (UxSTA<2>) is set if a '0' is detected instead of a Stop bit. If two Stop bits are selected, both Stop bits must be '1'; otherwise, FERR will be set. The read-only FERR bit is buffered along with the received data; it is cleared on any Reset.

18.5.3 PARITY ERROR (PERR)

The PERR bit (UxSTA<3>) is set if the parity of the received word is incorrect. This error bit is applicable only if a Parity mode (odd or even) is selected. The read-only PERR bit is buffered along with the received data bytes; it is cleared on any Reset.

18.5.4 IDLE STATUS

When the receiver is active (i.e., between the initial detection of the Start bit and the completion of the Stop bit), the RIDLE bit (UxSTA<4>) is '0'. Between the completion of the Stop bit and detection of the next Start bit, the RIDLE bit is '1', indicating that the UART is Idle.

18.5.5 RECEIVE BREAK

The receiver will count and expect a certain number of bit times based on the values programmed in the PDSEL (UxMODE<2:1>) and STSEL (UxMODE<0>) bits.

If the break is longer than 13 bit times, the reception is considered complete after the number of bit times specified by PDSEL and STSEL. The URXDA bit is set, FERR is set, zeros are loaded into the receive FIFO, interrupts are generated, if appropriate and the RIDLE bit is set.

When the module receives a long Break signal and the receiver has detected the Start bit, the data bits and the invalid Stop bit (which sets the FERR), the receiver must wait for a valid Stop bit before looking for the next Start bit. It cannot assume that the Break condition on the line is the next Start bit.

Break is regarded as a character containing all 0's, with the FERR bit set. The Break character is loaded into the buffer. No further reception can occur until a Stop bit is received. Note that RIDLE goes high when the Stop bit has not been received yet.

18.6 Address Detect Mode

Setting the ADDEN bit (UxSTA<5>) enables the Address Detect mode, in which a 9th bit (URX8) value of '1' identifies the received word as an address rather than data. This mode is only applicable for 9-bit data communication. The URXISEL control bit does not have any impact on interrupt generation in this mode, since an interrupt (if enabled) will be generated every time the received word has the 9th bit set.

18.7 Loopback Mode

Setting the LPBACK bit enables this special mode in which the UxTX pin is internally connected to the UxRX pin. When configured for the Loopback mode, the UxRX pin is disconnected from the internal UART receive logic. However, the UxTX pin still functions as in a normal operation.

To select this mode:

a) Configure UART for desired mode of operation.
b) Set LPBACK = 1 to enable Loopback mode.
c) Enable transmission as defined in **Section 18.3 "Transmitting Data"**.

18.8 Baud Rate Generator

The UART has a 16-bit Baud Rate Generator to allow maximum flexibility in baud rate generation. The Baud Rate Generator register (UxBRG) is readable and writable. The baud rate is computed as follows:

BRG = 16-bit value held in UxBRG register (0 through 65535)

FCY = Instruction Clock Rate (1/TCY)

The baud rate is given by Equation 18-1.

EQUATION 18-1: BAUD RATE

$$Baud\ Rate = F_{CY} / (16 * (BRG + 1))$$

Therefore, maximum baud rate possible is

FCY / 16 (if BRG = 0),

and the minimum baud rate possible is

FCY / (16 * 65536).

With a full 16-bit Baud Rate Generator, at 30 MIPs operation, the minimum baud rate achievable is 28.5 bps.

18.9 Auto Baud Support

To allow the system to determine baud rates of received characters, the input can be optionally linked to a selected capture input. To enable this mode, the user must program the input capture module to detect the falling and rising edges of the Start bit.

18.10 UART Operation During CPU Sleep and Idle Modes

18.10.1 UART OPERATION DURING CPU SLEEP MODE

When the device enters Sleep mode, all clock sources to the module are shut down and stay at logic ‘0’. If entry into Sleep mode occurs while a transmission is in progress, then the transmission is aborted. The UxTX pin is driven to logic ‘1’. Similarly, if entry into Sleep mode occurs while a reception is in progress, then the reception is aborted. The UxSTA, UxMODE, Transmit and Receive registers and buffers, and the UxBRG register are not affected by Sleep mode.

If the WAKE bit (UxMODE<7>) is set before the device enters Sleep mode, then a falling edge on the UxRX pin will generate a receive interrupt. The Receive Interrupt Select Mode bit (URXISEL) has no effect for this function. If the receive interrupt is enabled, then this will wake-up the device from Sleep. The UARTEN bit must be set in order to generate a wake-up interrupt.

18.10.2 UART OPERATION DURING CPU IDLE MODE

For the UART, the USIDL bit selects if the module will stop operation when the device enters Idle mode, or whether the module will continue on Idle. If USIDL = 0, the module will continue operation during Idle mode. If USIDL = 1, the module will stop on Idle.

FIGURE 20-3: TIME-OUT SEQUENCE ON POWER-UP ($\overline{MCLR}$ TIED TO VDD)

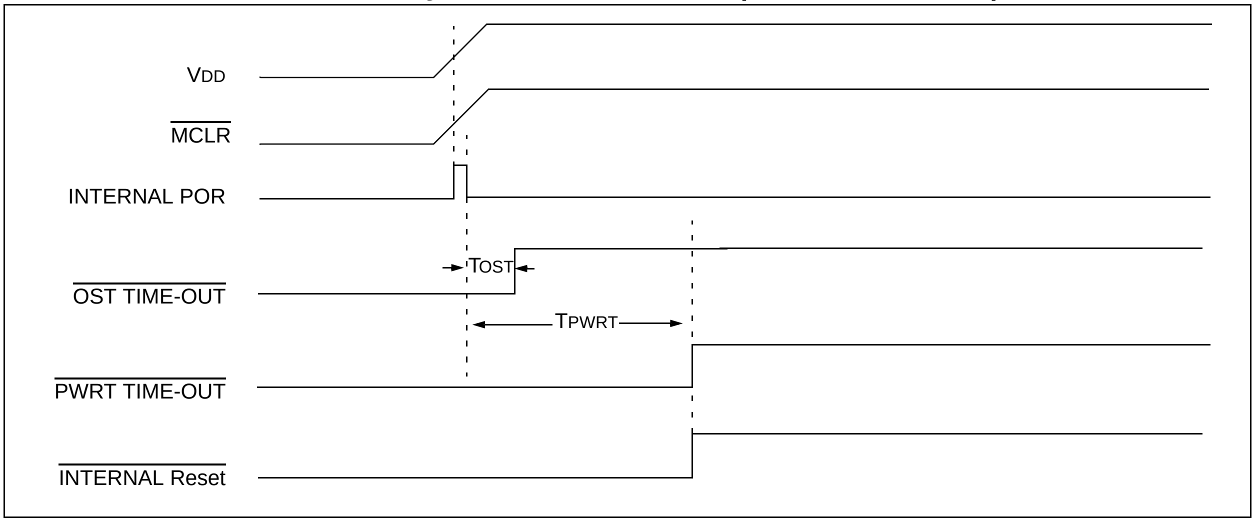


FIGURE 20-4: TIME-OUT SEQUENCE ON POWER-UP ($\overline{MCLR}$ NOT TIED TO VDD): CASE 1

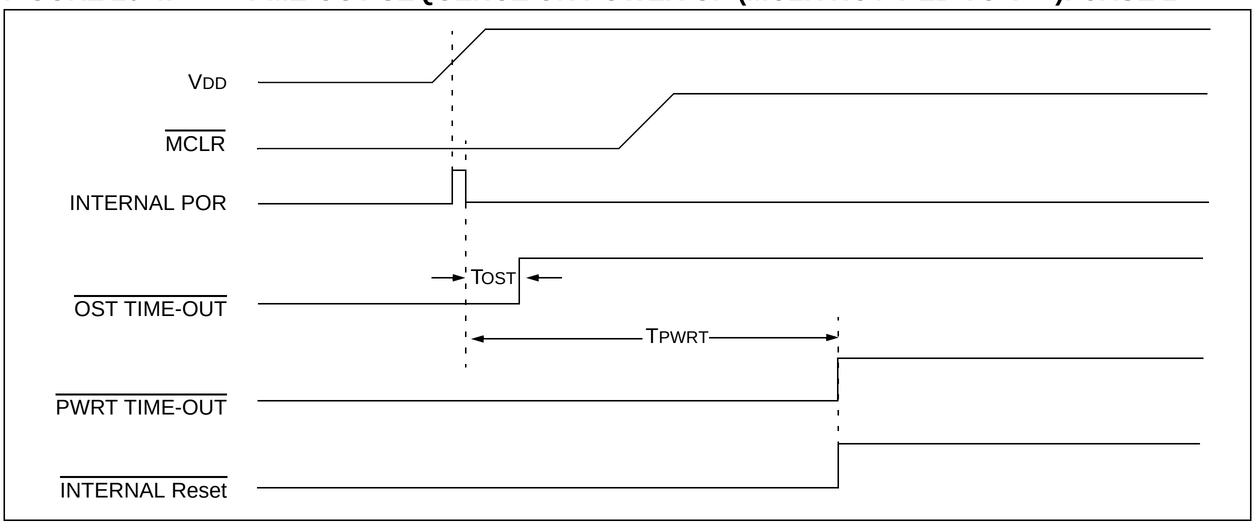
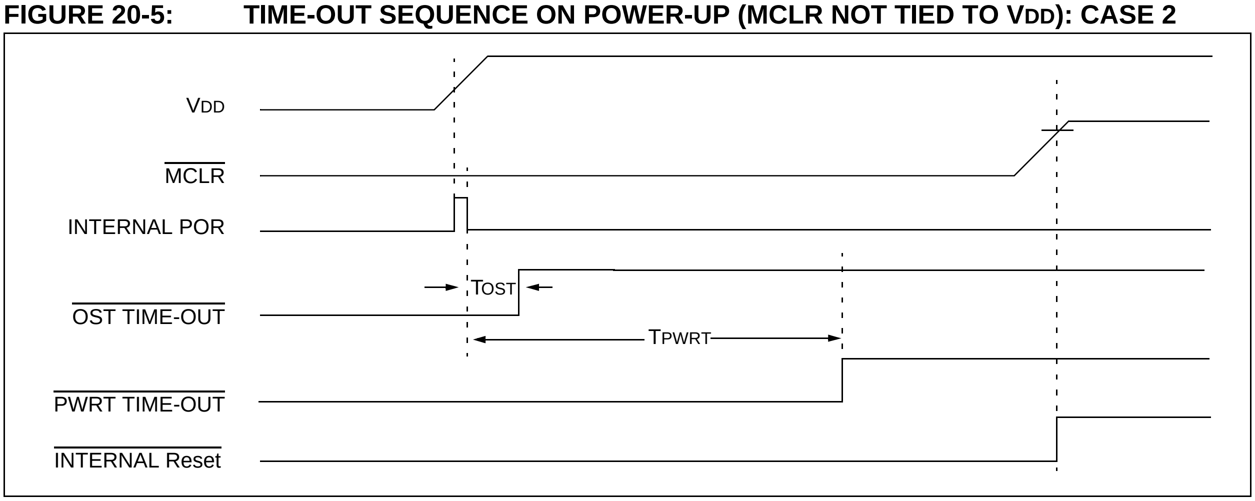


FIGURE 20-5: TIME-OUT SEQUENCE ON POWER-UP ($\overline{MCLR}$ NOT TIED TO VDD): CASE 2



23.2 AC Characteristics and Timing Parameters

The information contained in this section defines dsPIC30F AC characteristics and timing parameters.

TABLE 23-12: TEMPERATURE AND VOLTAGE SPECIFICATIONS – AC

AC CHARACTERISTICS	**Standard Operating Conditions: 2.5V to 5.5V (unless otherwise stated)** Operating temperature -40°C ≤ TA ≤ +85°C for Industrial -40°C ≤ TA ≤ +125°C for Extended Operating voltage VDD range as described in **Section 23.1 "DC Characteristics"**.

FIGURE 23-2: LOAD CONDITIONS FOR DEVICE TIMING SPECIFICATIONS

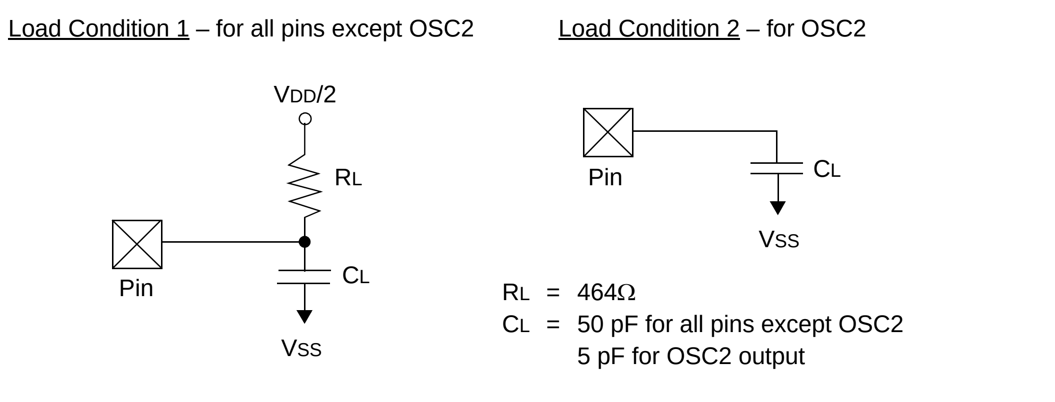


FIGURE 23-3: EXTERNAL CLOCK TIMING

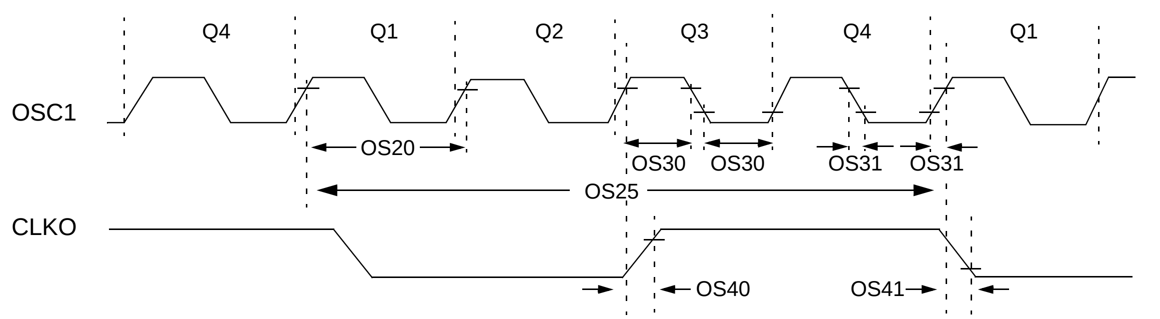
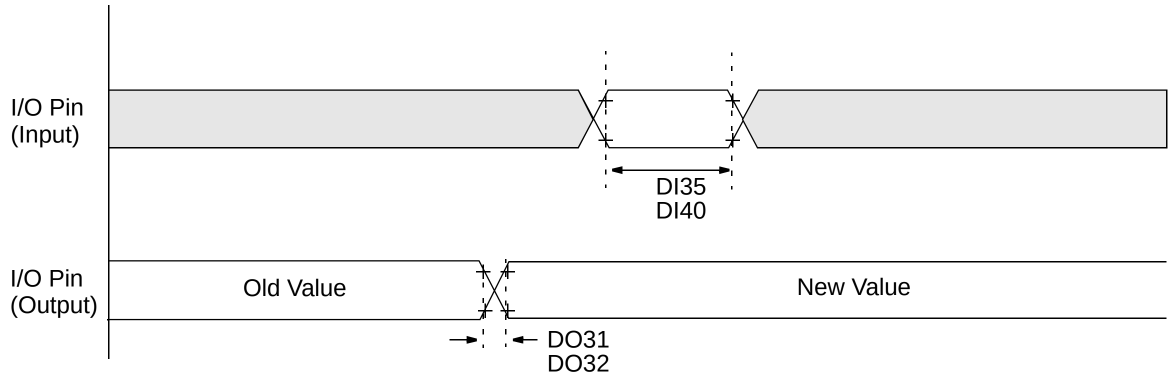


FIGURE 23-4: CLKO AND I/O TIMING CHARACTERISTICS



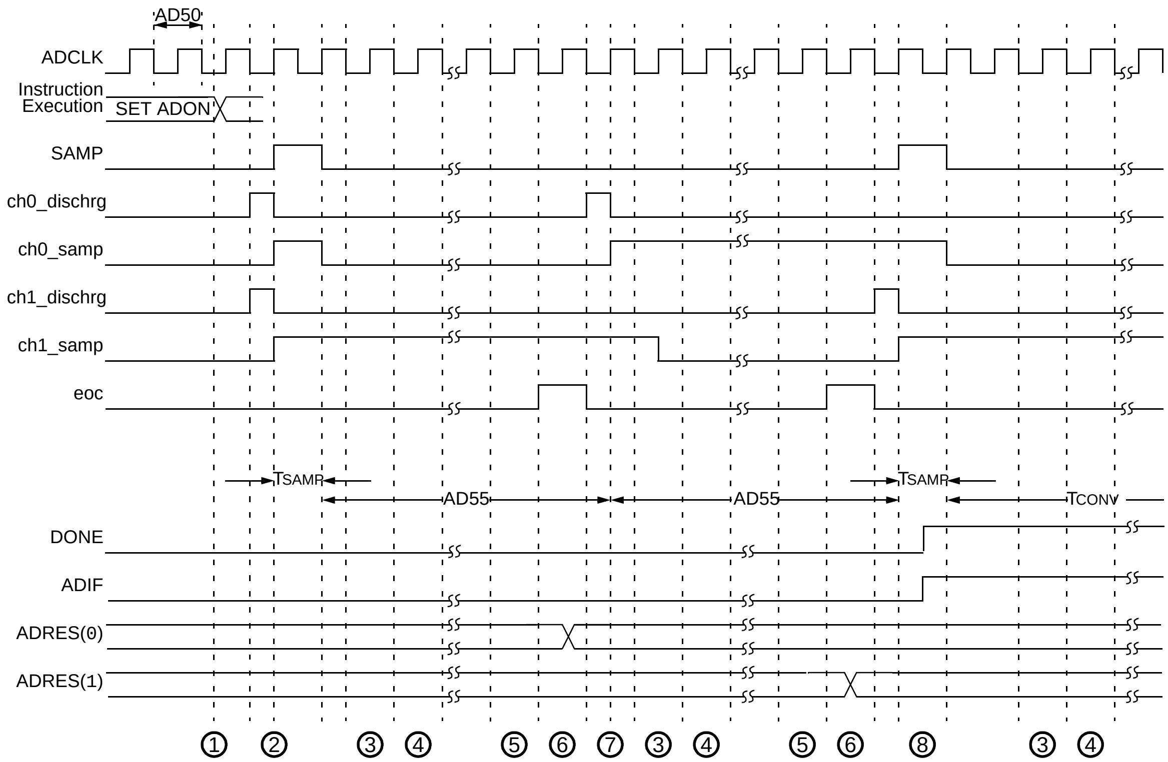
Note: Refer to Figure 23-2 for load conditions.

TABLE 23-19: CLKO AND I/O TIMING REQUIREMENTS

AC CHARACTERISTICS			Standard Operating Conditions: 2.5V to 5.5V (unless otherwise stated) Operating temperature -40°C ≤ TA ≤ +85°C for Industrial -40°C ≤ TA ≤ +125°C for Extended				
Param No.	**Symbol**	**Characteristic(1,2,3)**	**Min**	**Typ(4)**	**Max**	**Units**	**Conditions**
DO31	TIOR	Port Output Rise Time	—	7	20	ns	
DO32	TIOF	Port Output Fall Time	—	7	20	ns	
DI35	TINP	INTx Pin High or Low Time (output)	20	—	—	ns	
DI40	TRBP	CNx High or Low Time (input)	2 TCY	—	—	ns	

Note 1: These parameters are asynchronous events not related to any internal clock edges.
2: Measurements are taken in RC mode and EC mode where CLKO output is 4 x TOSC.
3: These parameters are characterized but not tested in manufacturing.
4: Data in “Typ” column is at 5V, 25°C unless otherwise stated.

FIGURE 23-25: 10-BIT HIGH-SPEED ADC TIMING CHARACTERISTICS (CHPS = 01, SIMSAM = 0, ASAM = 1, SSRC = 111, SAMC = 00001)



① — Software sets ADCON. ADON to start AD operation.

② — Sampling starts after discharge period.
TSAMP is described in **Section 17. "10-Bit A/D Converter"** of the *"dsPIC30F Family Reference Manual"* (DS70046).

③ — Convert bit 9.

④ — Convert bit 8.

⑤ — Convert bit 0.

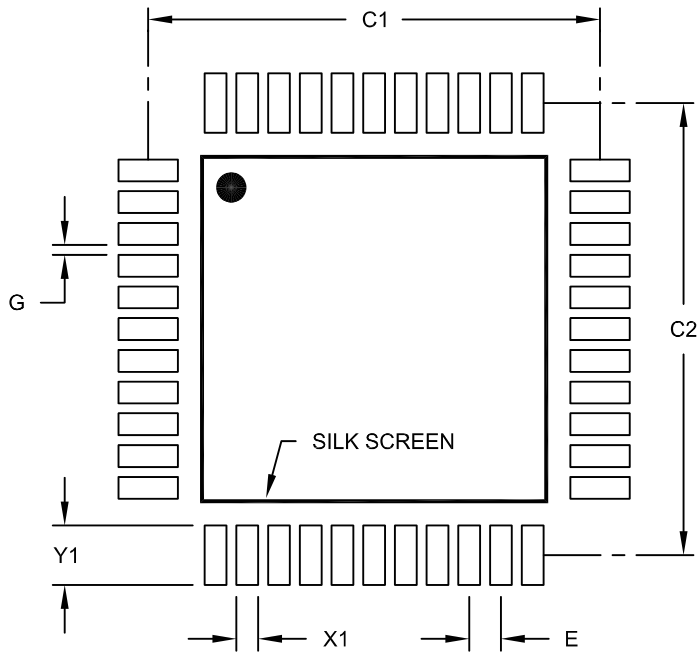
⑥ — One TAD for end of conversion.

⑦ — Begin conversion of next channel

⑧ — Sample for time specified by SAMC.
TSAMP is described in **Section 17. "10-Bit A/D Converter"** of the *"dsPIC30F Family Reference Manual"* (DS70046).

44-Lead Plastic Thin Quad Flatpack (PT) – 10x10x1 mm Body, 2.00 mm [TQFP]

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



RECOMMENDED LAND PATTERN

		Units	MILLIMETERS		
		Dimension Limits	MIN	NOM	MAX
Contact Pitch	E		0.80 BSC		
Contact Pad Spacing	C1			11.40	
Contact Pad Spacing	C2			11.40	
Contact Pad Width (X44)	X1				0.55
Contact Pad Length (X44)	Y1				1.50
Distance Between Pads	G		0.25		

Notes:

1. Dimensioning and tolerancing per ASME Y14.5M

   BSC: Basic Dimension. Theoretically exact value shown without tolerances.

Microchip Technology Drawing No. C04-2076A

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